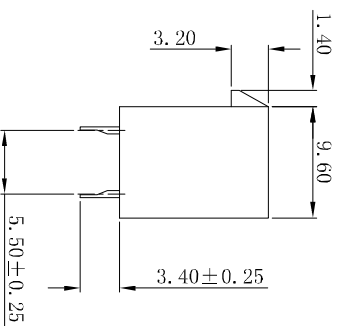
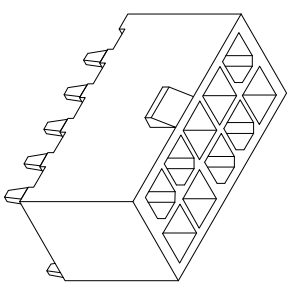
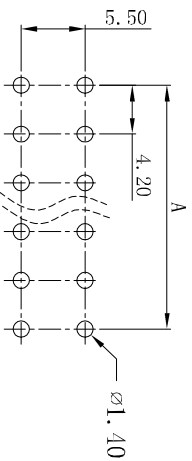
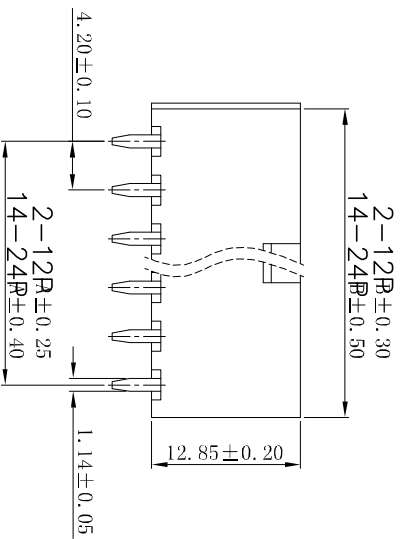
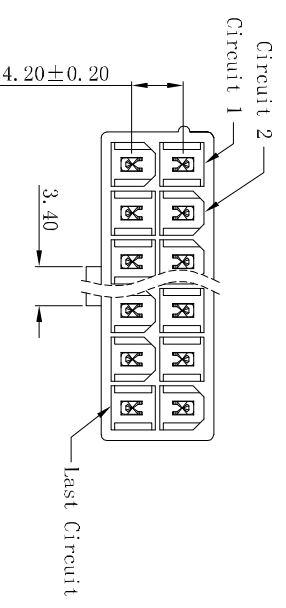
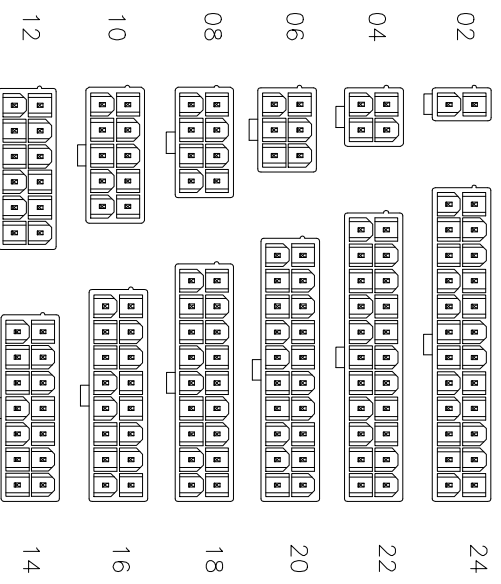


REV.	ECN NO.	DESCRIPTION	DATE	DESIGN
E		调整电气性能描述更新图框	2021.10.26	XUETAO9U0



WITHOUT "H" : WITH HALOGEN  
WITH "H" : HALOGEN FREE

NOTE:  
1. MATERIAL:SEE BOM  
2. SPEC. PLS. REFER TO E1057:  
· DIM. MARKED SHOULD BE MEASURED BY FAI;  
· DIM. MARKED SHOULD BE CONTROLLED BY QC;  
· DIM. MARKED SHOULD BE MEASURED TERMLY BY QC;  
· DIM. MARKED SHOULD BE ANALYSED TERMLY BY QC;  
3.ORDERING INFORMATION:  
WB4204 H -XX X X X - X  
PIN NO. X - X  
PACKING:  
O: TRAY  
1: TUBE  
□ : 不带定位柱  
Z: 带定位柱  
B: BLACK  
N: NATURAL  
PLATING SPEC  
S: MATT Sn GS: MATT Sn+GF  
G: GOLD FLASH  
T: GOLD 3U" ON CONTACT AREA



CKT.	DIM. A	DIM. B
2	/	5.60
4	4.20	9.80
6	8.40	14.00
8	12.60	18.20
10	16.80	22.40
12	21.00	26.60
14	25.20	30.80
16	29.40	35.00
18	33.60	39.20
20	37.80	43.40
22	42.00	47.60
24	46.20	51.80

2	TERMINAL	BRASS
1	HOUSING	PA66 UL94-V0
NO.	DESCRIPTION	Q'TY. MATERIAL

<p>一般公差 X: ±0.5 .XX ±0.2 .X ±0.3 .XXX ±0.1 ANGLES ±2°</p>		<p>品名 (TITLE) 4.2mm PITCH WAFER 180度 空芯 CONNECTION SERIES</p>	
<p>SYMBOLS  INDICATE CLASSIFICATION DIMENSION</p>		<p>圖號 (PNG NO.) C-WB4204H-XXXXX</p>	
<p> MARK IS CRITICAL DIM.  MARK IS MAJOR DIM.</p>		<p>製圖 (DR) XUETAO9U0 審核 (CHK) LEO-HH 核准 (APP) LEO-HH</p>	
<p>表面處理 (FINISH)</p>		<p>比例 (SCALE) 5:1 單位 (UNITS) mm 張數 (SHEET) 1 OF 1 SIZE A4 REV E</p>	

希尔盛精密电子(昆山)有限公司